

# **Enhancement Mode N-Channel Power MOSFET**

PDFN5x6/NMOS/40V/ $\pm$ 20V/70A/1.9V/3.8m $\Omega$ 

Rev<sub>0.1</sub>





# 40V, 3.8mΩ, 70A, Single N-Channel

#### 1.Features

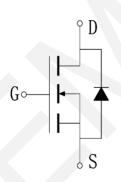
- ◆ 40V MOSFET technology
- ◆ Low on-state resistance
- Fast switching
- ♦ Vgs±20V
- ◆ 100% RG Tested
- ◆ 100% UIS Tested

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- Power Switching Application
- ◆ Load Switching



V <sub>DS</sub>	R <sub>DS(on)</sub> Typ.	I <sub>D</sub> Max.
40)/	3.8mΩ @ 10V	70.4
40V	5.3mΩ @ 4.5V	70A



Schematic Diagram

### 3. Package Marking and Ordering Information

Part no.	Marking	Package	PCS/Reel	PCS/CTN.
WX038N04PA	038N04	PDFN5X6	5,000	50,000

### 4.Absolute Max Ratings at Ta=25°C (Note1)

Parameter	Symbol	Maximum	Units
Drain to Source Voltage	$V_{ extsf{DSS}}$	40	V
Gate to Source Voltage	$V_{GSS}$	±20	V
Drain Current (DC)	I <sub>D</sub>	70	А
Drain Current (Pulse), PW≤300μs	I <sub>DP</sub>	280	А
Total Dissipation	$P_{D}$	42	W
Avalanche Energy, Single Pulsed	E <sub>AS</sub>	36	mJ
Junction Temperature	T <sub>j</sub>	150	°C
Storage Temperature	$T_{stg}$	-55 to +150	°C

Note 1: Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.



### 5.Thermal Resistance Ratings

Parameter	Symbol	Value	Unit
Junction to case	R <sub>eJC</sub>	1.4	°C/W

Note 2: When mounted on 1 inch square copper board  $t \le 10$ sec The value in any given application depends on the user's specific board design.

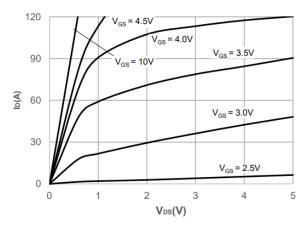
#### 6.Electrical Characteristics at Ta=25°C (Note 3)

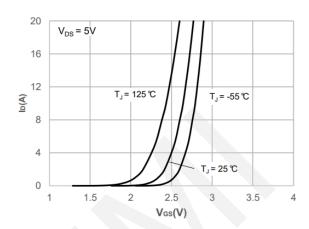
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Units
Drain to Source Breakdown Voltage	V <sub>(BR)DSS</sub>	$I_D = 250 \mu A, V_{GS} = 0 V$	40	-	-	٧
Zero-Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS}$ =40V, $V_{GS}$ = 0V	-	-	1	μΑ
Gate to Source Leakage Current	I <sub>GSS</sub>	$V_{GS} = \pm 20V, V_{DS} = 0V$	ı	-	±100	nA
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}$ , $I_{DS}=250\mu A$	1	1.9	2.5	V
Static Drain to Source On-State	Б	$I_D = 30A, V_{GS} = 10V$	-	3.8	5.0	mΩ
Resistance	R <sub>DS(on)</sub>	$I_D = 20A, V_{GS} = 4.5V$	-	5.3	7.5	mΩ
Input Capacitance	C <sub>iss</sub>	V <sub>GS</sub> =0V,	-	1204	-	pF
Output Capacitance	$C_{oss}$	V <sub>DS</sub> =20V,	-	536	-	pF
Reverse Transfer Capacitance	C <sub>rss</sub>	Frequency=1.0MHz	1	51	-	pF
Turn-ON Delay Time	t <sub>d(on)</sub>		ı	4.8	-	ns
Rise Time	t <sub>r</sub>	$V_{DD} = 20V, I_{D} = 20A$	-	8.6	-	ns
Turn-OFF Delay Time	$t_{d(off)}$	$V_{GS} = 10V$ , $R_G = 3\Omega$	-	23	-	ns
Fall Time	t <sub>f</sub>		ı	15.2	-	ns
	$Q_g$ $V_{DS} = 20V$ ,		ı	17.9	-	nC
Total Gate Charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10V, I <sub>D</sub> = 20A	-	3.2	-	nC
	$Q_{gd}$		1	4.0	-	nC
Diode Forward Voltage	V <sub>FSD</sub>	I <sub>S</sub> = 30A, V <sub>GS</sub> = 0	-	-	1.2	V

Note 3: Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

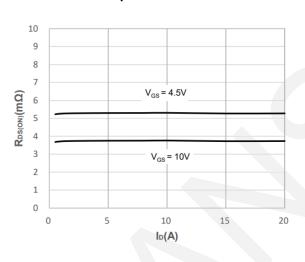


## 7. Typical electrical and thermal characteristics

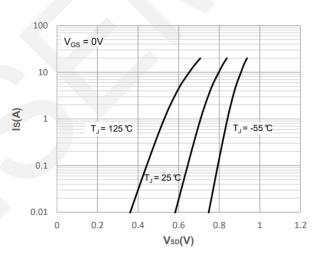




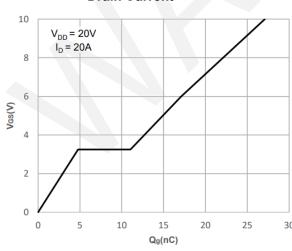
**Output Characteristics** 



**Transfer Characteristics** 

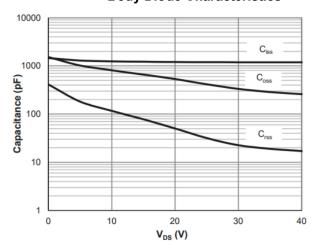


**Drain Current** 



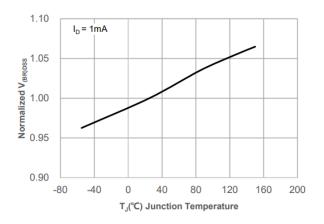
**Gate Charge Characteristics** 

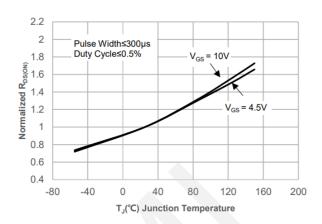
**Body Diode Characteristics** 



**Capacitance Characteristics** 

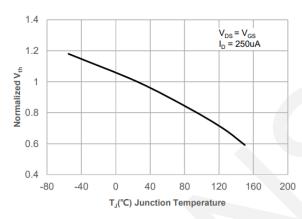






Normalized Breakdown voltage vs. Junction Temperature

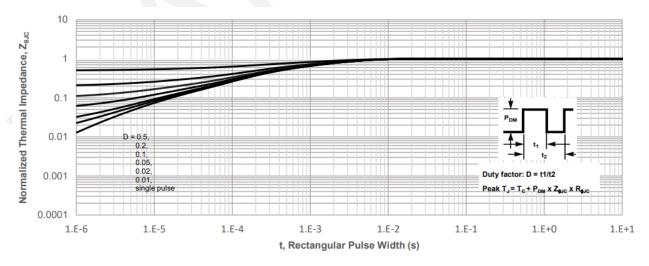
Normalized on Resistance vs. Junction Temperature



1000 Limited by R<sub>DS(ON)</sub> 1us 100 10us 10 100us 1ms 10ms 1 T<sub>C</sub> = 25 ℃ Single Puse 0.1 0.1 10 100 V<sub>DS</sub>(V)

Normalized Threshold Voltage vs. Junction Temperature

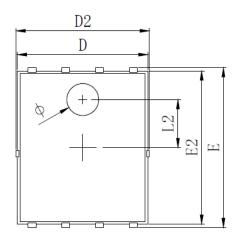
**Maximum Safe Operating Area** 

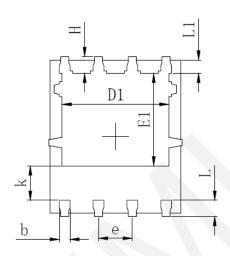


Normalized Maximum Transient Thermal Impedance



## 8.Package Dimensions





SYMBOL		MILLIMETER	
SIMDUL	MIN	Typ.	MAX
A	0. 900	1. 000	1. 100
A1		0.254 REF.	
A2		0~0.05	
D	4. 824	4. 900	4. 976
D1	3. 910	4. 010	4. 110
D2	4. 924	5. 000	5. 076
Е	5. 924	6. 000	6.076
E1	3. 375	3. 475	3. 575
E2	5. 674	5. 750	5.826
ь	0. 350	0. 400	0.450
е	1.270 TYP.		
L	0. 534	0. 610	0. 686
L1	0. 424	0. 500	0. 576
L2	1.800 REF.		
k	1. 190	1. 290	1.390
Н	0. 549	0. 625	0.701
θ	8°	10°	12°
ф	1. 100	1. 200	1. 300
d			0. 100



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